

### Features

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Idea for printed circuit board
- ◆ Metal-Silicon junction chip
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed  
250°C/10 seconds at terminals

### Mechanical Data

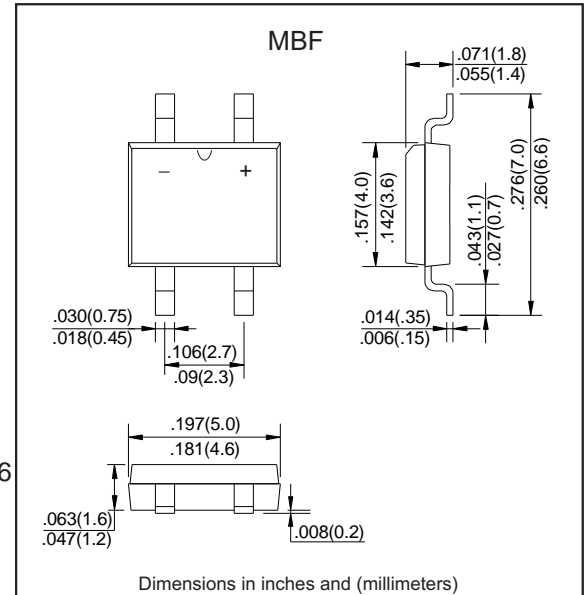
**Case** : Molded plastic body

**Terminals** : Solder plated, solderable per MIL-STD-750, Method 2026

**Polarity** : Polarity symbol marking on body

**Mounting Position** : Any

### Package outline



### Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	KMB 22F	KMB 24F	KMB 26F	KMB 28F	KMB 210F	KMB 215F	KMB 220F	UNITS
Maximum repetitive peak reverse voltage	$V_{RRM}$	20	40	60	80	100	150	200	V
Maximum RMS voltage	$V_{RMS}$	14	28	42	56	70	70	140	V
Maximum DC blocking voltage	$V_{DC}$	20	40	60	80	100	150	200	V
Maximum average forward rectified current at $T_L=100^\circ\text{C}$ On glass-epoxy P.C.B (Note 1)	$I_{(AV)}$	2.0							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	50.0							A
Rating for fusing ( $t=8.3\text{ms}$ , $T_a=25^\circ\text{C}$ )	$I_t^2$	10.37							$\text{A}^2\text{s}$
Maximum instantaneous forward voltage at 2.0A	$V_F$	0.55	0.7	0.85	0.95				V
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=125^\circ\text{C}$	$I_R$	0.5 50			0.2 20				mA
Typical thermal resistance	$R_{qJA}$	85.0							$^\circ\text{C}/\text{W}$
Operating junction temperature range	$T_J$	-55 to +125			-55 to +150				$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-55 to +150							$^\circ\text{C}$

**Note:**1. Mounted on glass epoxy PC board with 1.3\*1.3mm solder pad

### Ratings And Characteristic Curves

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

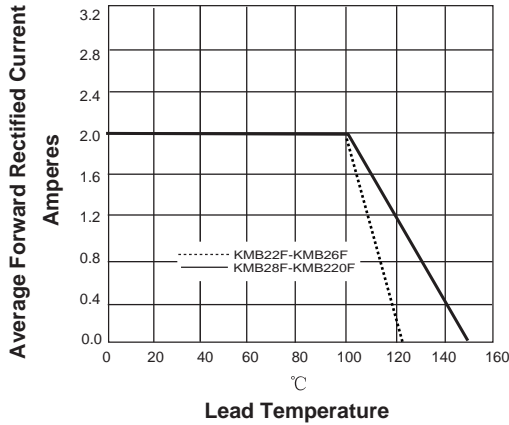


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PERLEG

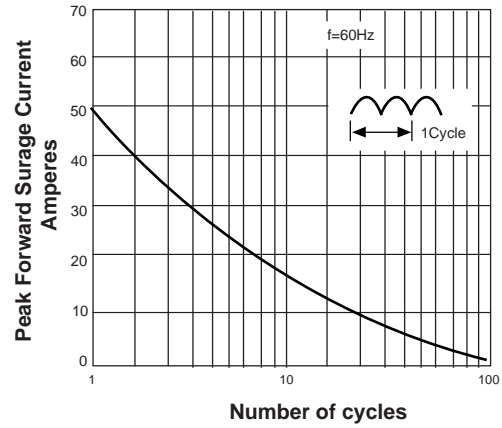


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

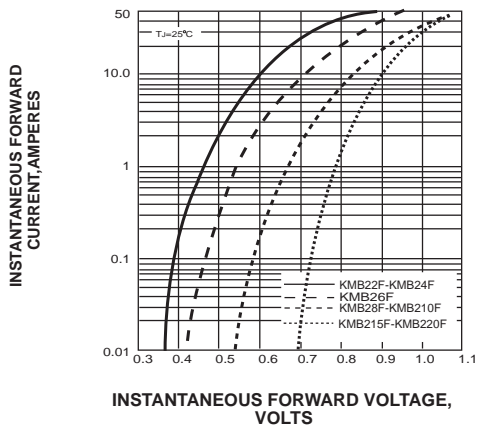
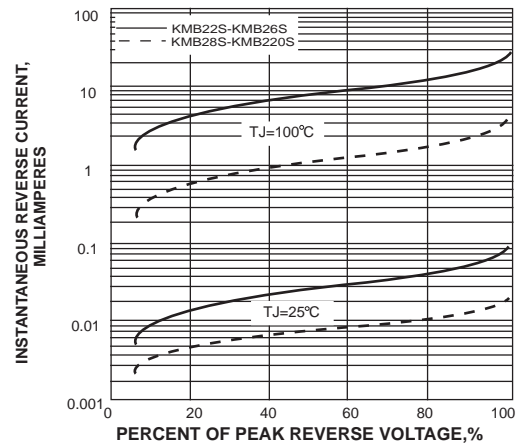
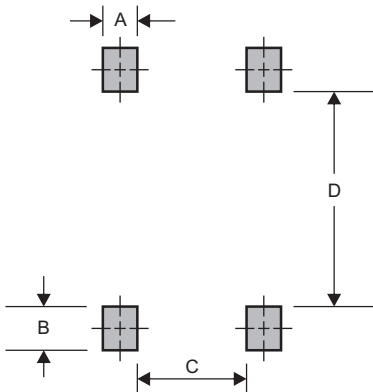


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



### Suggested Pad Layout



Dimensions in inches and (millimeters)

PACKAGE	A	B	C	D
MBF	0.023 (0.58)	0.030 (0.76)	0.070 (1.78)	0.226 (5.75)

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